

# **ARM Cortex-A8**

# **Intel Core i7**

E. Sanchez

**Politecnico di Torino**  
**Dipartimento di Automatica e Informatica**

# ARM Cortex-A8

Introduced by ARM in 2005, it is the first processor supporting the ARMv7-A architecture.

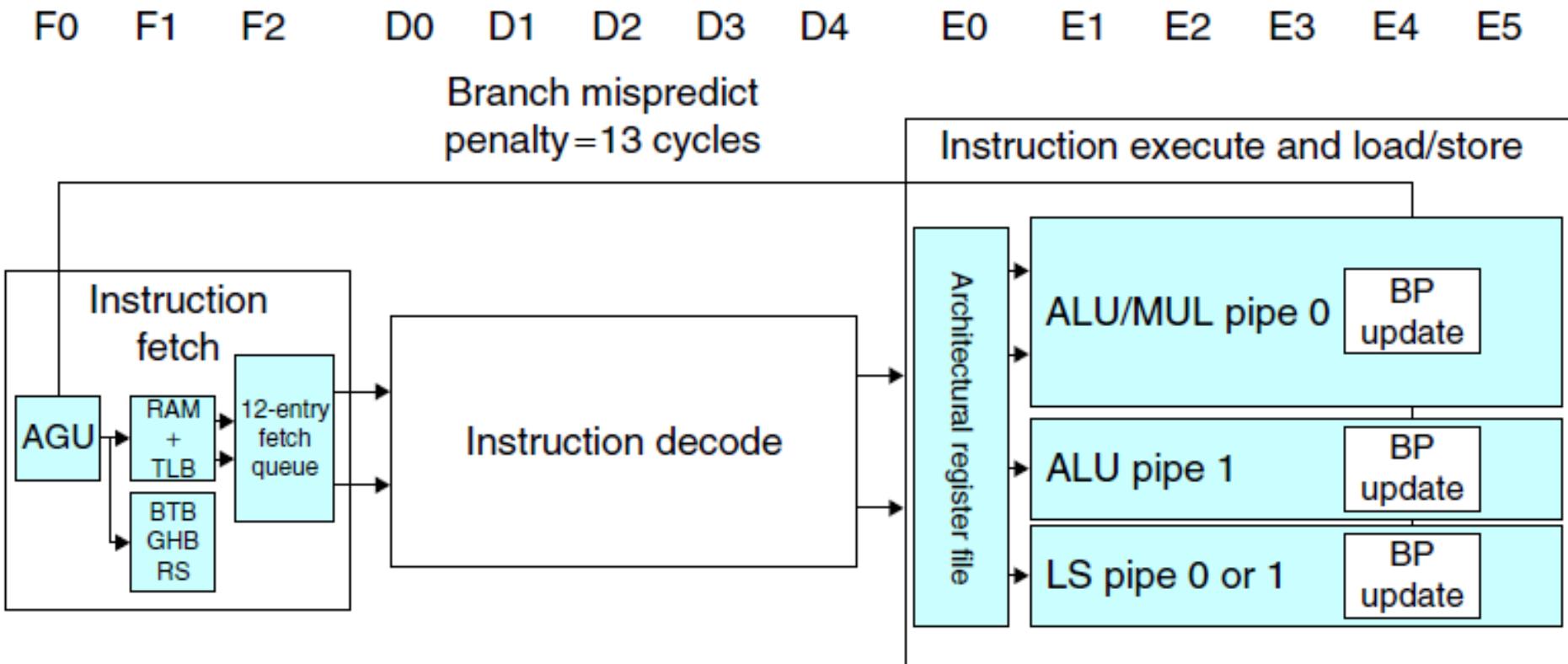
First ARM superscalar processor, running at high frequencies: from 600MHz to 1GHz.

Used in PMD, mainly in smart phones, and tablets.

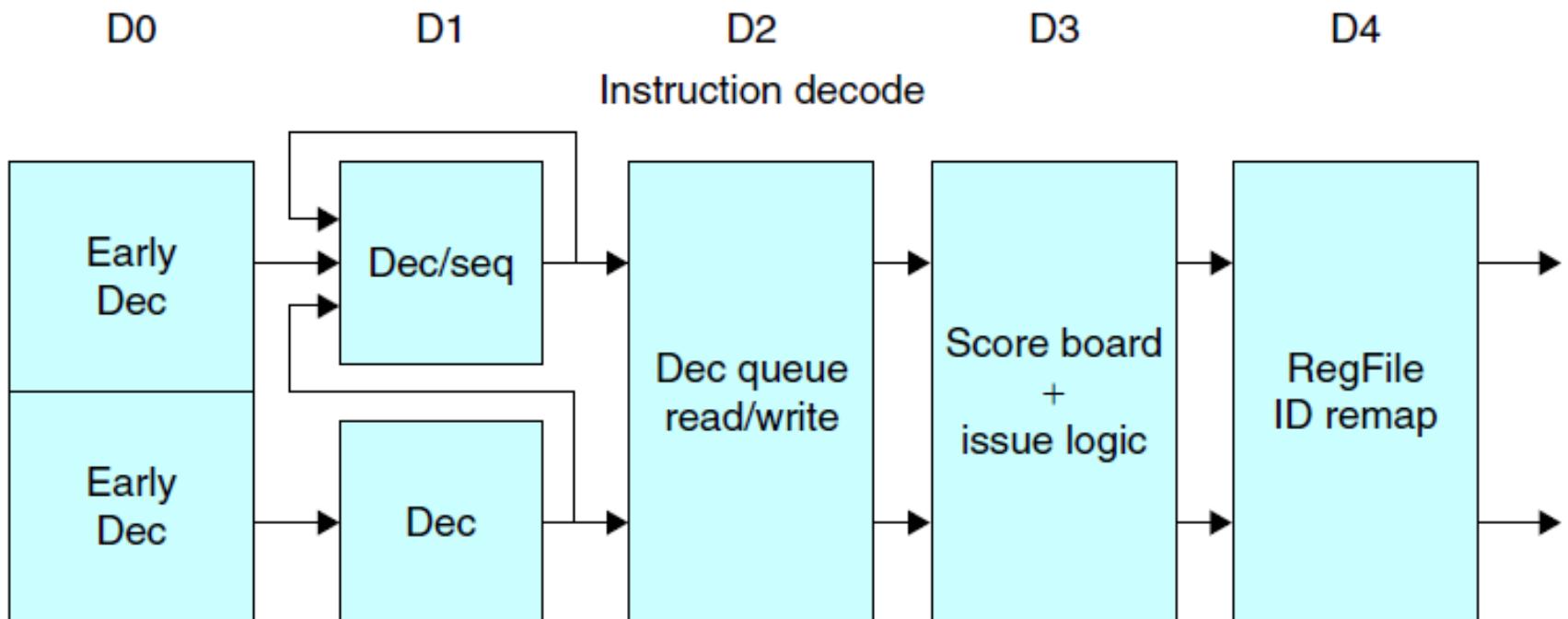
Main characteristics:

- Dual issue
- Statically scheduled
- Dynamic issue detection
- Dynamic branch prediction two-level with a BTB.

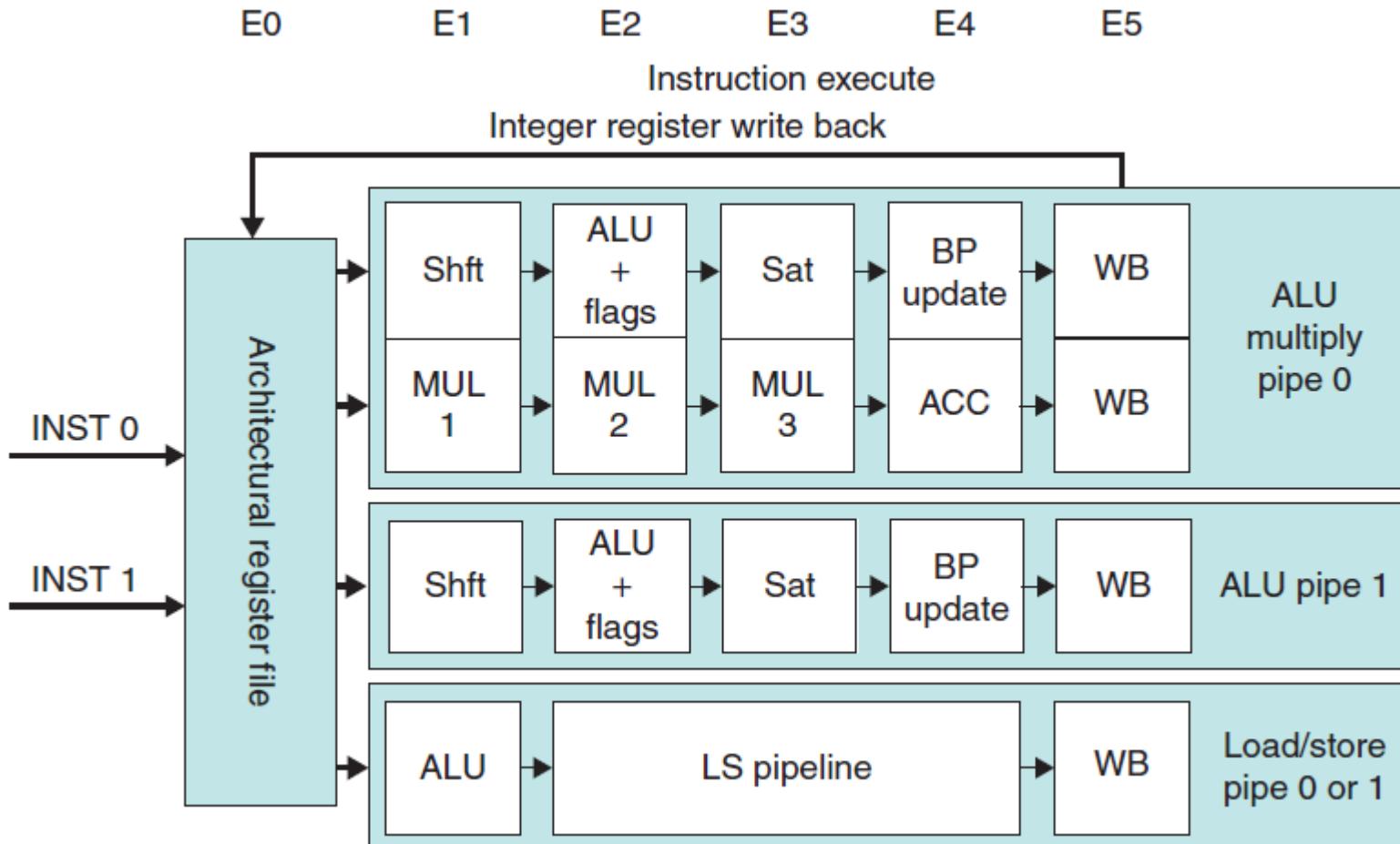
# A8 pipeline



# Decode unit



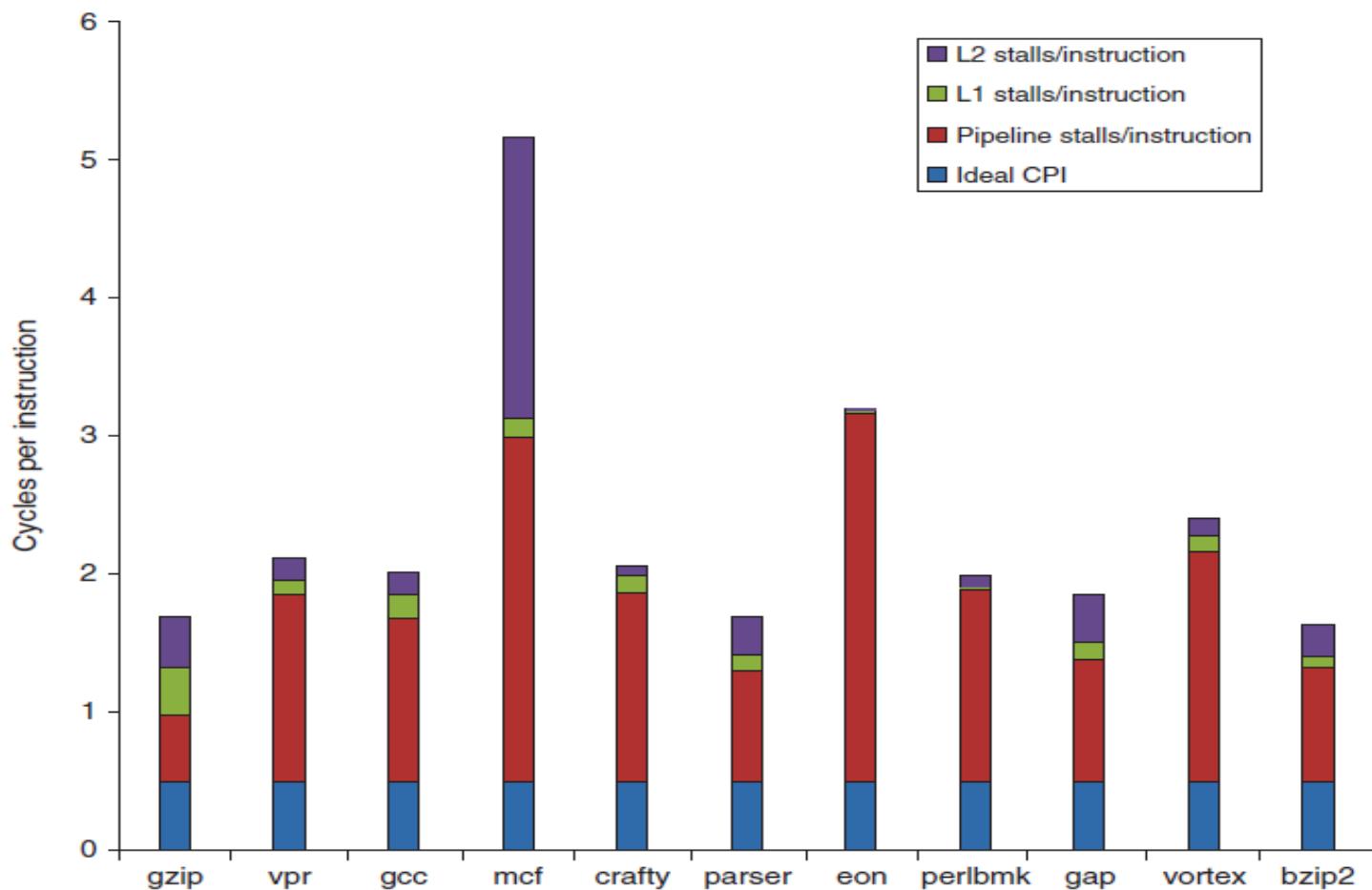
# Execution unit



# Pipeline stalls

- Structural hazards
  - 2 instruction in the issue packet use the same functional unit
- Data hazards
  - It is a compiler task to avoid data hazards
- Control hazards
  - Misprediction penalty: 13 cc

# A8 performance



# **Intel core i7**

**Intel 64-bit x86-64 processor introduced in 2008.  
Superscalar processor core with out-of-order and  
speculation features.**

**Distributed as multicore devices for the desktop and  
laptop markets.**

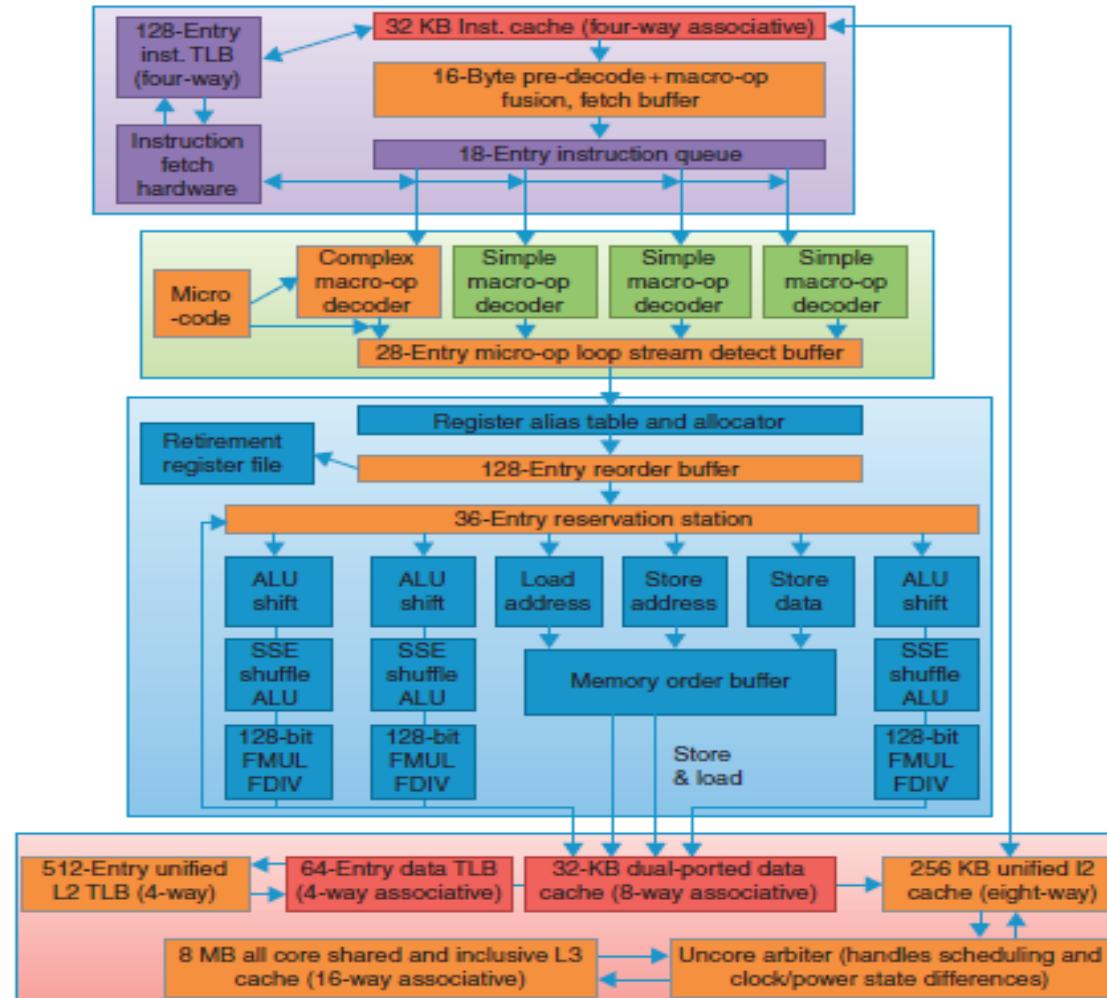
- 3 cache levels**
- 45 nm**
- ~ 730 million transistors**
- High clock frequencies: 2.66 GHz – 3.20 GHz**

# i7 pipeline details

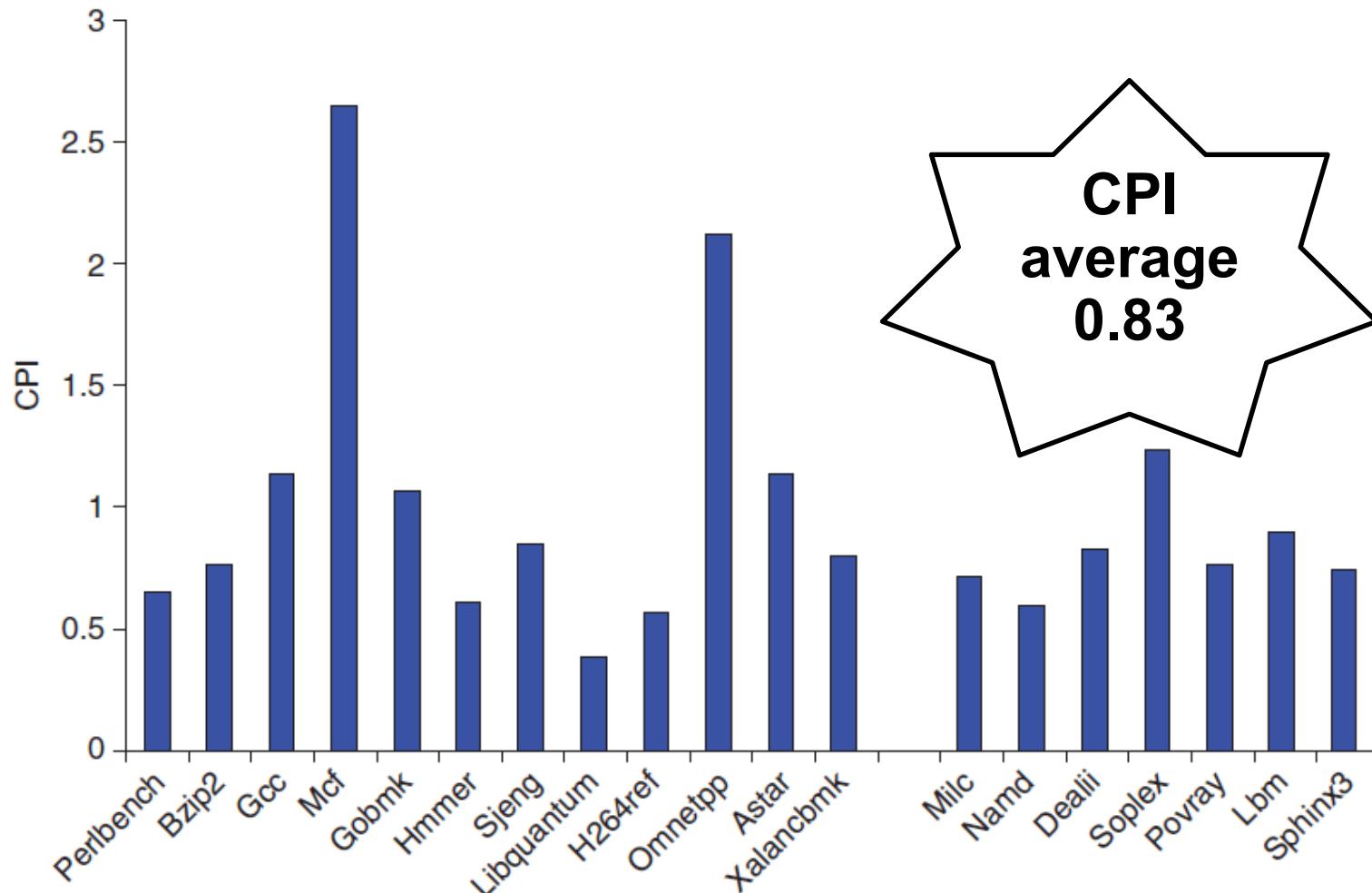
i7 processor supports x86 instructions that can be decoded in 1 to 17 bytes.

- The total pipeline depth is 14 stages
- Up to 4 instructions issued for clock cycle
- Branch mispredictions cost 15 cycles
- 48 load and 32 store buffers
- Six independent functional units
- Up to six instruction issues in the same clock cycle
- ROB 128 entries
- Reservation Stations 36 entries.

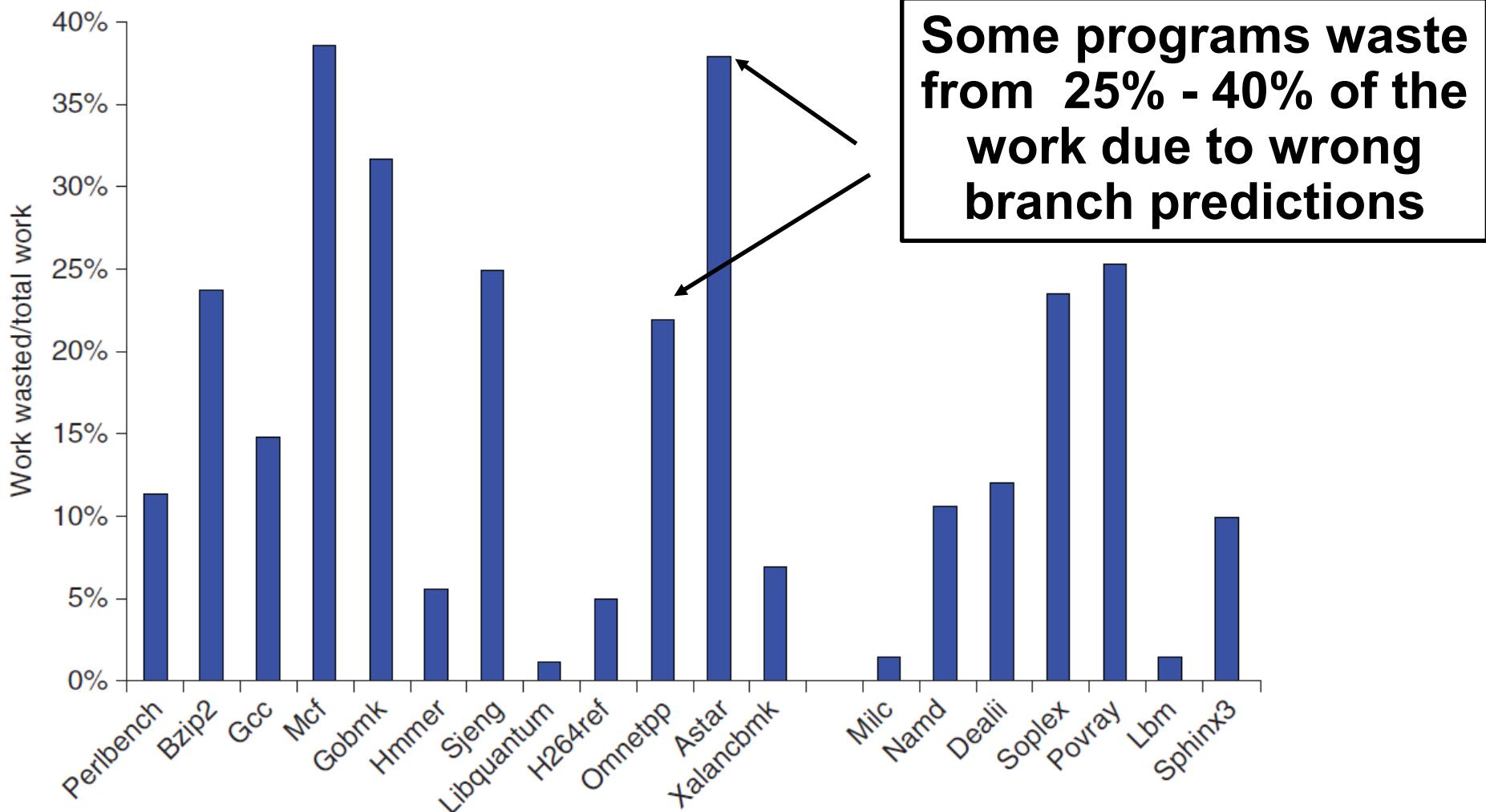
# Intel Core i7 pipeline



# Processor performance



# Wasted work information



Some programs waste  
from 25% - 40% of the  
work due to wrong  
branch predictions

		Intel i7 920	ARM A8	Intel Atom 230
Area	Specific characteristic	Four cores, each with FP	One core, no FP	One core, with FP
Physical chip properties	Clock rate	2.66 GHz	1 GHz	1.66 GHz
	Thermal design power	130 W	2 W	4 W
	Package	1366-pin BGA	522-pin BGA	437-pin BGA
Memory system	TLB	Two-level All four-way set associative 128 I/64 D 512 L2	One-level fully associative 32 I/32 D	Two-level All four-way set associative 16 I/16 D 64 L2
		Three-level 32 KB/32 KB 256 KB 2–8 MB		Two-level 16/16 or 32/32 KB 128 KB–1MB 512 KB
	Peak memory BW	17 GB/sec	12 GB/sec	8 GB/sec
Pipeline structure	Peak issue rate	4 ops/clock with fusion	2 ops/clock	2 ops/clock
	Pipeline scheduling	Speculating out of order	In-order dynamic issue	In-order dynamic issue
	Branch prediction	Two-level 512-entry BTB 4K global history 8-entry return stack		Two-level